

## 2SJ619

Switching Regulator and DC-DC Converter Applications  
Motor Drive Applications

- 4-V gate drive
- Low drain-source ON resistance:  $R_{DS(ON)} = 0.15 \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 7.7 S$  (typ.)
- Low leakage current:  $I_{DSS} = -100 \mu A$  (max) ( $V_{DS} = -100 V$ )
- Enhancement-model:  $V_{th} = -0.8$  to  $-2.0 V$  ( $V_{DS} = -10 V$ ,  $I_D = -1 mA$ )

### Maximum Ratings ( $T_a = 25^\circ C$ )

| Characteristics                                |                | Symbol    | Rating     | Unit       |
|--|----------------|-----------|------------|------------|
| Drain-source voltage                           |                | $V_{DSS}$ | -100       | V          |
| Drain-gate voltage ( $R_{GS} = 20 k\Omega$ )   |                | $V_{DGR}$ | -100       | V          |
| Gate-source voltage                            |                | $V_{GSS}$ | $\pm 20$   | V          |
| Drain current                                  | DC (Note 1)    | $I_D$     | -16        | A          |
|  | Pulse (Note 1) | $I_{DP}$  | -64        |            |
| Drain power dissipation ( $T_c = 25^\circ C$ ) |                | $P_D$     | 75         | W          |
| Single pulse avalanche energy (Note 2)         |                | $E_{AS}$  | 292        | mJ         |
| Avalanche current                              |                | $I_{AR}$  | -16        | A          |
| Repetitive avalanche energy (Note 3)           |                | $E_{AR}$  | 7.5        | mJ         |
| Channel temperature                            |                | $T_{ch}$  | 150        | $^\circ C$ |
| Storage temperature range                      |                | $T_{stg}$ | -55 to 150 | $^\circ C$ |

### Thermal Characteristics

| Characteristics                     | Symbol         | Max  | Unit         |
|-------------------------------------|----------------|------|--------------|
| Thermal resistance, channel to case | $R_{th(ch-c)}$ | 1.67 | $^\circ C/W$ |

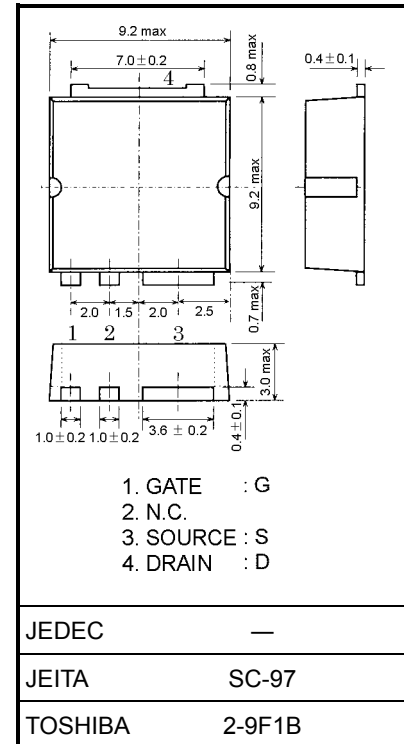
Note 1: Please use devices on condition that the channel temperature is below  $150^\circ C$ .

Note 2:  $V_{DD} = -25 V$ ,  $T_{ch} = 25^\circ C$  (initial),  $L = 1.84 mH$ ,  $R_G = 25 \Omega$ ,  $I_{AR} = -16 A$

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

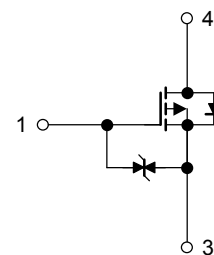
This transistor is an electrostatic sensitive device. Please handle with caution.

Unit: mm

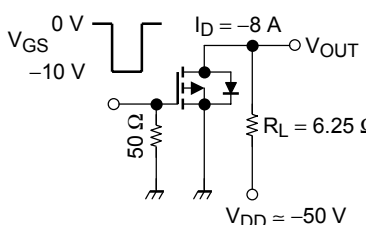


Weight: 0.74 g (typ.)

### Circuit Configuration



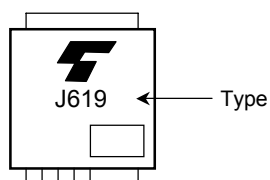
## Electrical Characteristics (Ta = 25°C)

| Characteristics                                 |               | Symbol        | Test Condition   | Min  | Typ. | Max      | Unit          |
|---|---------------|---------------|--|------|------|----------|---------------|
| Gate leakage current                            |               | $I_{GSS}$     | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$  | —    | —    | $\pm 10$ | $\mu\text{A}$ |
| Drain cut-OFF current                           |               | $I_{DSS}$     | $V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$  | —    | —    | -100     | $\mu\text{A}$ |
| Drain-source breakdown voltage                  |               | $V_{(BR)DSS}$ | $I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$   | -100 | —    | —        | V             |
| Gate threshold voltage                          |               | $V_{th}$      | $V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$  | -0.8 | —    | -2.0     | V             |
| Drain-source ON resistance                      |               | $R_{DS(ON)}$  | $V_{GS} = -4 \text{ V}, I_D = -6 \text{ A}$  | —    | 0.25 | 0.32     | $\Omega$      |
|   |               |               | $V_{GS} = -10 \text{ V}, I_D = -6 \text{ A}$   | —    | 0.15 | 0.21     |               |
| Forward transfer admittance                     |               | $ Y_{fs} $    | $V_{DS} = -10 \text{ V}, I_D = -6 \text{ A}$   | 4.5  | 7.7  | —        | S             |
| Input capacitance                               |               | $C_{iss}$     | $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$  | —    | 1100 | —        | pF            |
| Reverse transfer capacitance                    |               | $C_{rss}$     |  | —    | 210  | —        |               |
| Output capacitance                              |               | $C_{oss}$     |  | —    | 440  | —        |               |
| Switching time                                  | Rise time     | $t_r$         | <br>$V_{GS} = 0 \text{ V}, -10 \text{ V}$<br>$I_D = -8 \text{ A}$<br>$R_L = 6.25 \Omega$<br>$V_{DD} \approx -50 \text{ V}$<br>Duty $\leq 1\%$ , $t_w = 10 \mu\text{s}$ | —    | 18   | —        | ns            |
|   | Turn-ON time  | $t_{on}$      |  | —    | 30   | —        |               |
|   | Fall time     | $t_f$         |  | —    | 18   | —        |               |
|   | Turn-OFF time | $t_{off}$     |  | —    | 65   | —        |               |
| Total gate charge (gate-source plus gate-drain) |               | $Q_g$         | $V_{DD} \approx -80 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -16 \text{ A}$  | —    | 48   | —        | nC            |
| Gate-source charge                              |               | $Q_{gs}$      |  | —    | 29   | —        |               |
| Gate-drain ("miller") charge                    |               | $Q_{gd}$      |  | —    | 19   | —        |               |

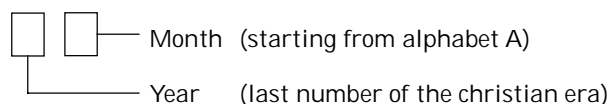
## Source-Drain Ratings and Characteristics (Ta = 25°C)

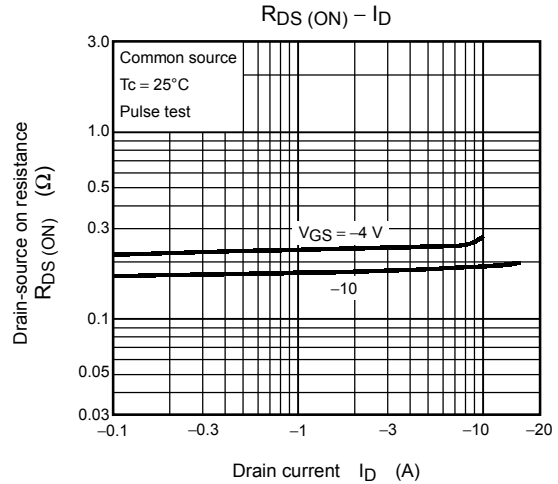
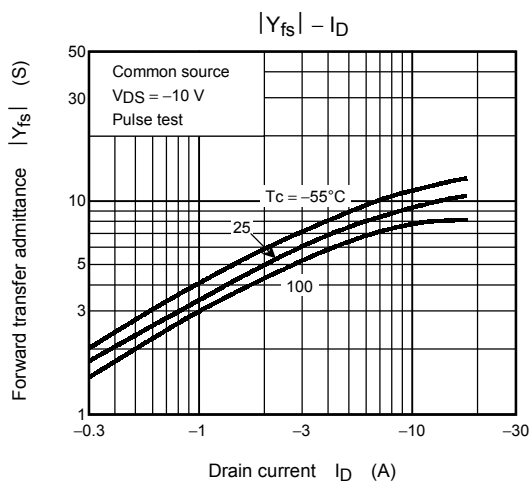
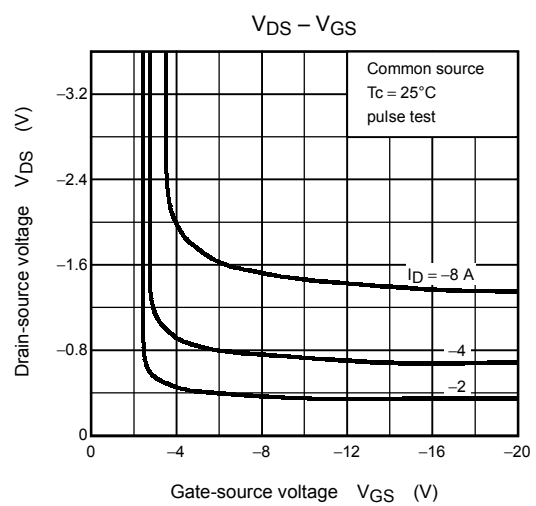
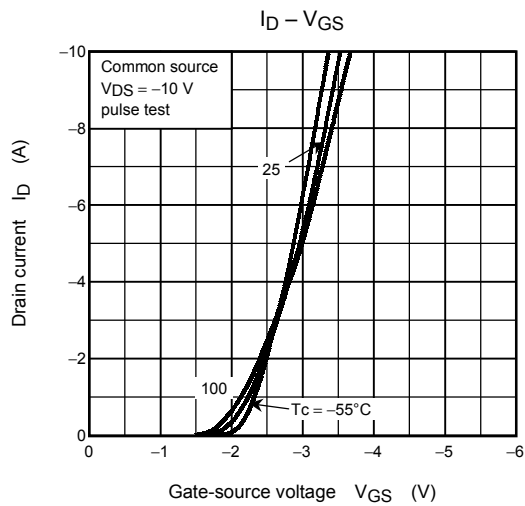
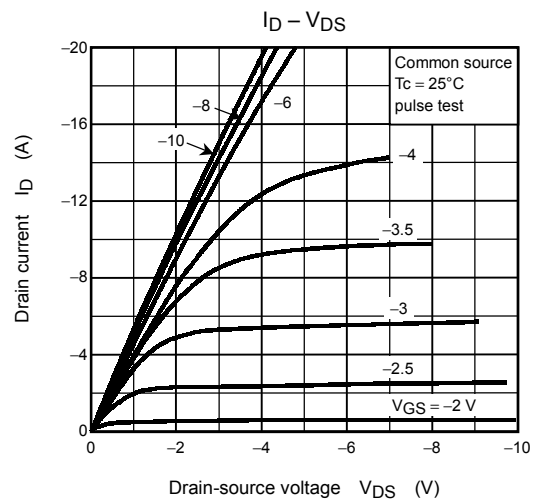
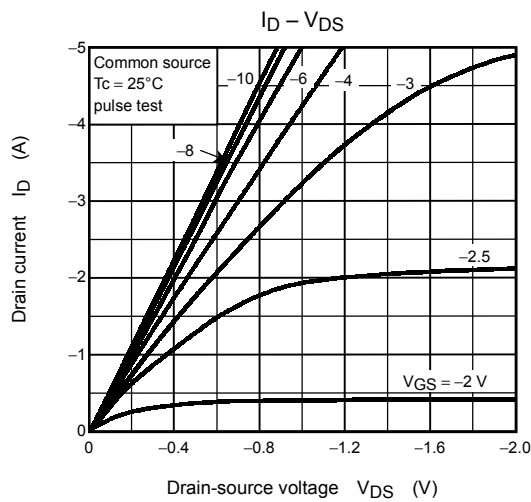
| Characteristics                           | Symbol    | Test Condition                                  | Min | Typ. | Max | Unit          |
|---|-----------|---|-----|------|-----|---------------|
| Continuous drain reverse current (Note 1) | $I_{DR}$  | —   | —   | —    | -16 | A             |
| Pulse drain reverse current (Note 1)      | $I_{DRP}$ | —   | —   | —    | -64 | A             |
| Forward voltage (diode)                   | $V_{DSF}$ | $I_{DR} = -16 \text{ A}, V_{GS} = 0 \text{ V}$  | —   | —    | 1.7 | V             |
| Reverse recovery time                     | $t_{rr}$  | $I_{DR} = -16 \text{ A}, V_{GS} = 0 \text{ V},$ | —   | 160  | —   | $\mu\text{s}$ |
| Reverse recovery charge                   | $Q_{rr}$  | $dI_{DR}/dt = 50 \text{ A}/\mu\text{s}$         | —   | 0.5  | —   | $\mu\text{C}$ |

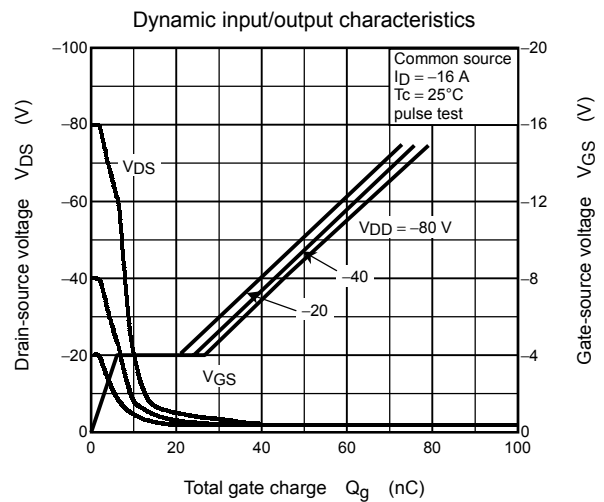
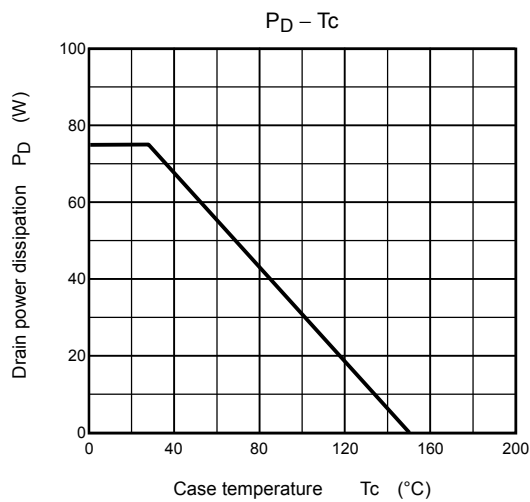
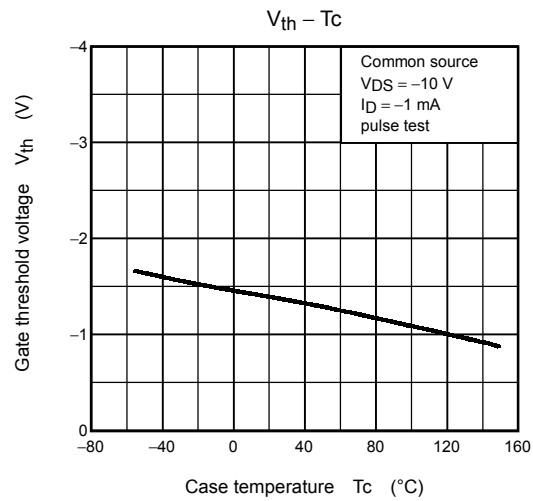
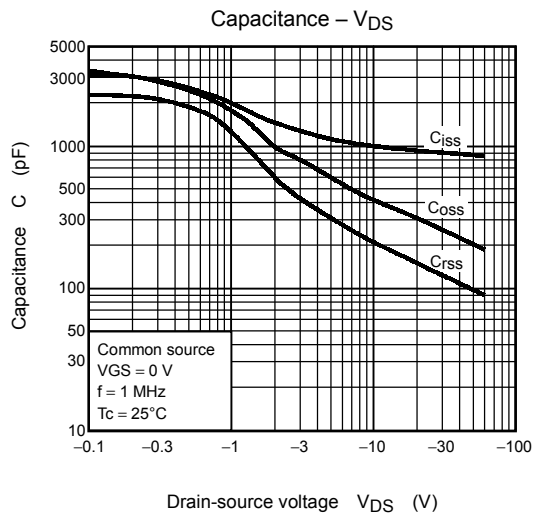
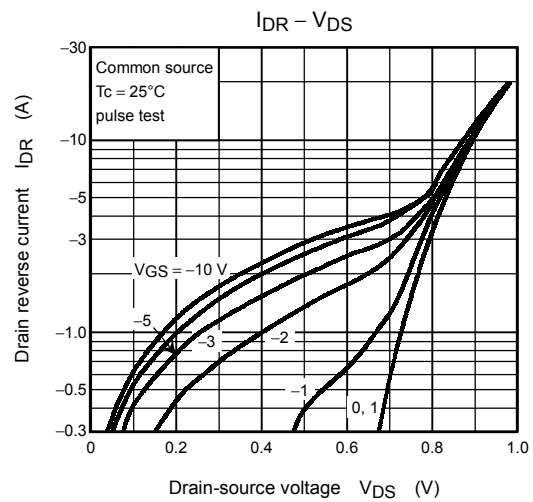
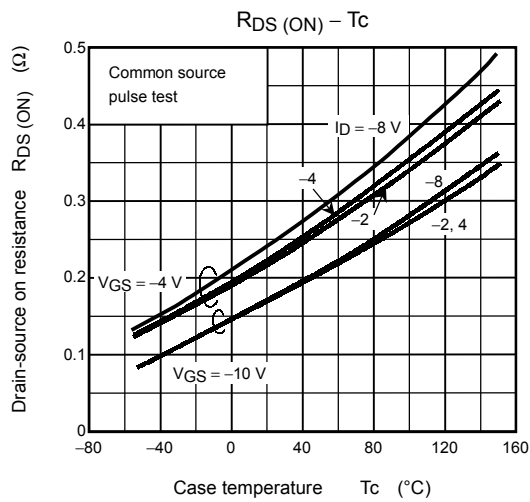
## Marking

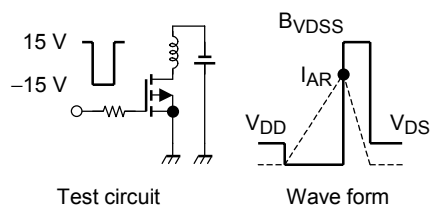
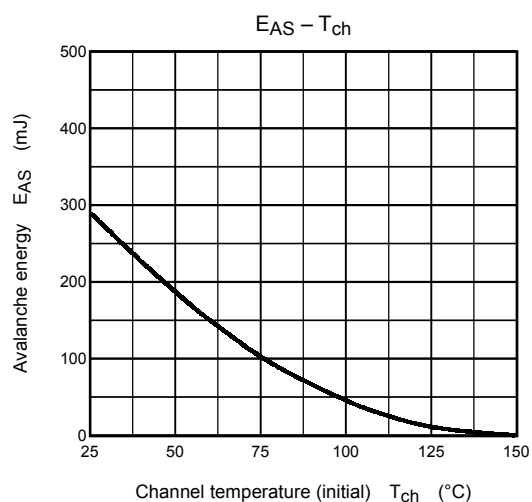
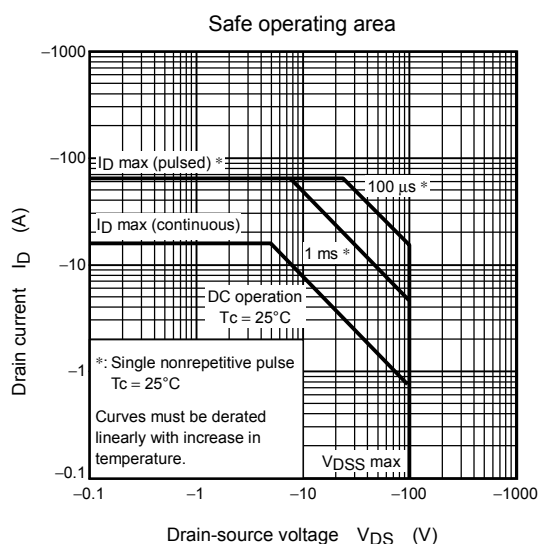
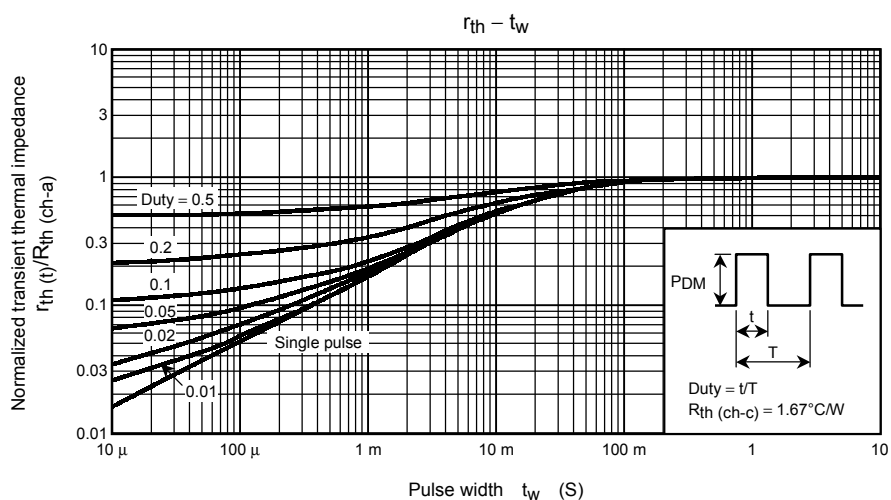


Lot Number









$$R_G = 25 \, \Omega$$

$$V_{DD} = -25 \, V, L = 1.84 \, mH$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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